Vishay Siliconix



HVMDIP

PRODUCT SUMMARY

V_{DS} (V)

R_{DS(on)} (Ω)

Q_{qs} (nC)

Q_{ad} (nC)

Qg (Max.) (nC)

Configuration

Power MOSFET

s

N-Channel MOSFET

0.10

60

25

5.8

11

Single

V_{GS} = 10 V

FEATURES

- Dynamic dV/dt rating
- For Automatic insertion
- End stackable
- 175 °C operating temperature
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION	
Package	HVMDIP
Lead (Pb)-free	IRFD024PbF

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	60	- V		
Gate-source voltage		V _{GS}	± 20			
Continuous drain current	$V_{GS} \text{ at } 10 \text{ V} \qquad \frac{T_A = 25 \text{ °C}}{T_A = 100 \text{ °C}}$	T _A = 25 °C	I _D	2.5		
Continuous drain current		T _A = 100 °C		1.8	A	
Pulsed drain current ^a			I _{DM}	20	7	
Linear derating factor				0.0083	W/°C	
Single pulse avalanche energy ^b			E _{AS}	91	mJ	
Maximum power dissipation $T_A = 25 \text{ °C}$		PD	1.3	W		
Peak diode recovery dV/dt ^c			dV/dt	4.5	V/ns	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +175	- °C	
Soldering recommendations (peak temperature) d	For 10 s		-	300		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 16 mH, $R_g = 25 \Omega$, $I_{AS} = 2.5 \text{ A}$ (see fig. 12)

c. $I_{SD} \le 17$ A, dl/dt ≤ 140 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C

d. 1.6 mm from case

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	120	°C/W

S21-0885-Rev. D, 30-Aug-2021

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IRFD024

PARAMETER	SYMBOL	TES	ST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static								
Drain-source breakdown voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	60	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	ce to 25 °C, I _D = 1 mA	-	0.061	-	V/°C	
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V	
Gate-source leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA	
Zero gate voltage drain current	I _{DSS}		= 60 V, V _{GS} = 0 V , V _{GS} = 0 V, T _J = 150 °C	-	-	25 250	μA	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 1.5 A ^b	-	-	0.10	Ω	
Forward transconductance	g _{fs}	V _{DS} =	= 25 V, I _D = 1.5 A ^b	0.90	-	-	S	
Dynamic		-		I	1	1		
Input capacitance	C _{iss}	$V_{GS} = 0 V,$		-	640	-	pF	
Output capacitance	C _{oss}		$V_{\text{GS}} = 0 V,$ $V_{\text{DS}} = 25 V,$		360	-		
Reverse transfer capacitance	C _{rss}	f = 1	.0 MHz, see fig. 5	-	79	-		
Total gate charge	Qg			-	-	25		
Gate-source charge	Q _{gs}	V _{GS} = 10 V	I _D = 17 A, V _{DS} = 48 V, see fig. 6 and 13 ^b	-	-	5.8	nC	
Gate-drain charge	Q _{gd}		see lig. o and to	-	-	11		
Turn-on delay time	t _{d(on)}			-	13	-		
Rise time	tr	Voo	= 30 V, I _D = 17 A,	-	58	-		
Turn-off delay time	t _{d(off)}		$R_{g} = 18 \Omega, R_{D} = 1.7\Omega, \text{ see fig. 1 0}^{b}$		25	-	ns	
Fall time	t _f			-	42	-		
Internal drain inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	-		
Internal source inductance	L _S			-	6.0	-	nH	
Drain-Source Body Diode Characteristic	s	<u>.</u>						
Continuous source-drain diode current	ا _S	MOSFET symbol showing the		-	-	2.5	_	
Pulsed diode forward current ^a	I _{SM}	integral revers p - n junction	÷ ===/	-	-	20	A	
Body diode voltage	V _{SD}	T _J = 25 °C	, I _S = 2.5 A, V _{GS} = 0 V ^b	-	-	1.5	V	
Body diode reverse recovery time	t _{rr}	T 05 00 1	17 A dl/dt 100 A/b	-	80	180	ns	
Body diode reverse recovery charge	Q _{rr}	$I_{\rm J} = 25 {}^{\circ}{\rm C}, I_{\rm F}$	= 17 A, dl/dt = 100 A/µs ^b	-	0.29	0.64	μC	
Forward turn-on time	t _{on}	Intrinsic tu	Irn-on time is negligible (turn	on is dor	ninated b	y L _S and	L _D)	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

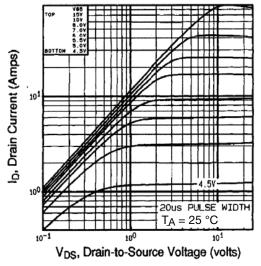


Fig. 1 - Typical Output Characteristics, $T_A = 25 \ ^{\circ}C$

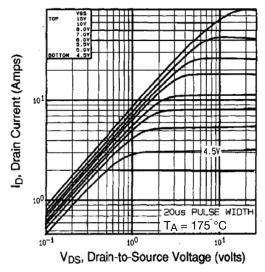


Fig. 1 - Typical Output Characteristics, T_A = 175 °C

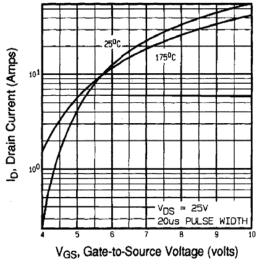


Fig. 2 - Typical Transfer Characteristics

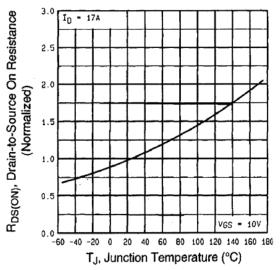


Fig. 3 - Normalized On-Resistance vs. Temperature



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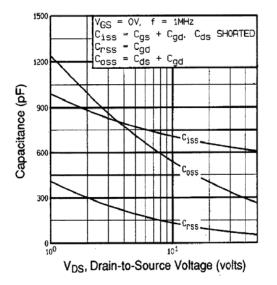


Fig. 4 - Typical Capacitance vs. Drain-to-Source Voltage

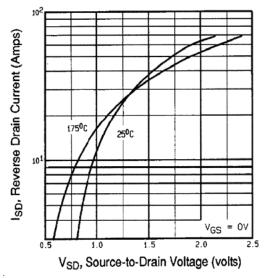


Fig. 6 - Typical Source-Drain Diode Forward Voltage

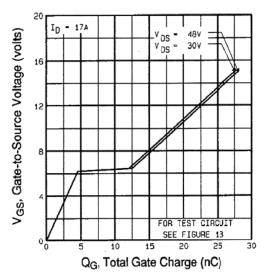
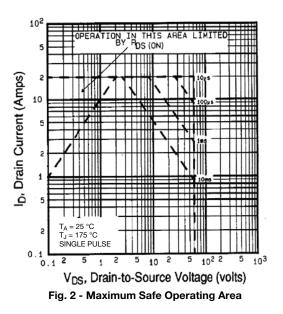


Fig. 5 - Typical Gate Charge vs. Gate-to-Source Voltage



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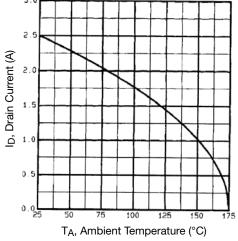


Fig. 7 - Maximum Drain Current vs. Ambient Temperature

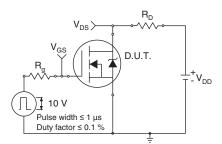


Fig. 10a - Switching Time Test Circuit

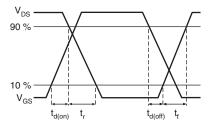


Fig. 10b - Switching Time Waveforms

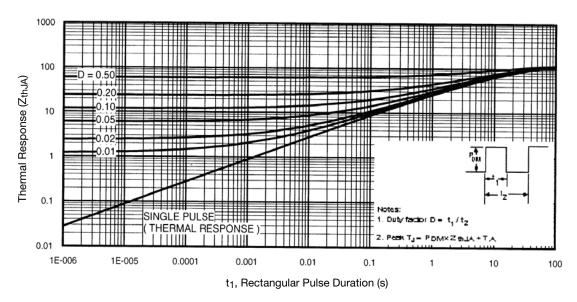


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



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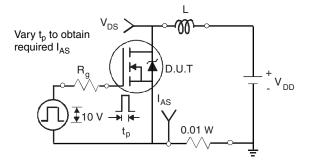


Fig. 12a - Unclamped Inductive Test Circuit

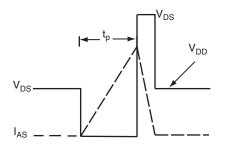


Fig. 12b - Unclamped Inductive Waveforms

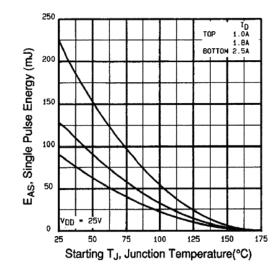
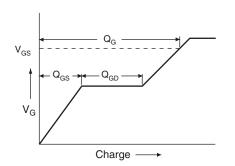


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





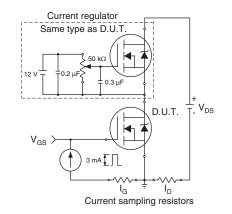


Fig. 13b - Gate Charge Test Circuit

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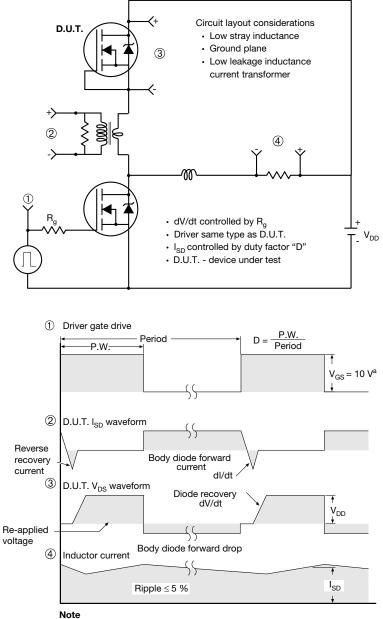
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Peak Diode Recovery dV/dt Test Circuit



a. V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel

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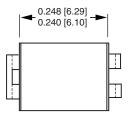
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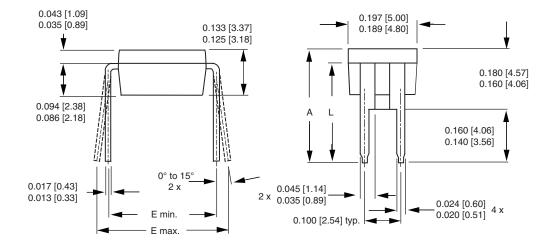
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HVM DIP (High voltage)





	INCHES		MILLIN	IETERS
DIM.	MIN.	MAX.	MIN.	MAX.
А	0.310	0.330	7.87	8.38
E	0.300	0.425	7.62	10.79
L	0.270	0.290	6.86	7.36
ECN: X10-0386-Rev. B, 0 DWG: 5974	06-Sep-10			

Note

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.



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Revision: 01-Jan-2024